

Close Roof Mounted System Temperature Estimation for Compliance to IEC TS 63126

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IEC 63126 Background

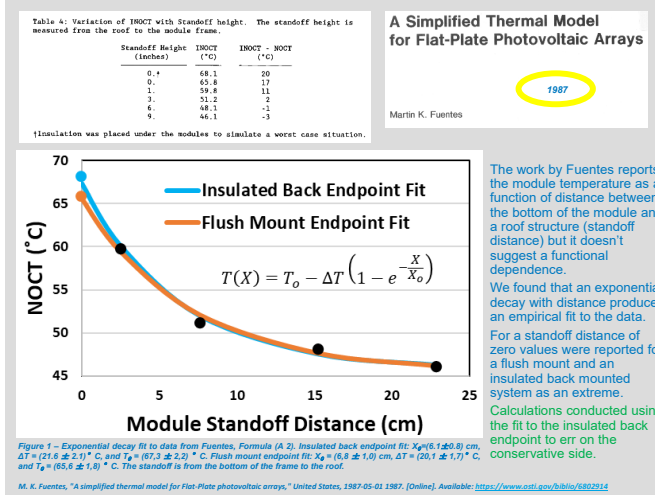
IEC TS 63126: Guidelines for qualifying PV modules, components and materials for operation at high temperatures, gives recommended testing conditions for modules deployed such that they would exceed a 98th percentile module temperature (T_{98}) of greater than 70 °C for Level 1 and 80 °C for a Level 2 designation. This was intended to replace the requirement that modules be suitable for operation in an environmental air temperature range of -40 °C to +40 °C in IEC 61730 [2] and IEC 61215 [3]. The concerns were that air temperature alone is not an adequate predictor of module temperature, and air temperatures in many locations exceed +40 °C. The use of T_{98} provided a metric to account for location and system configuration and was found to be a robust metric that is not sensitive to yearly fluctuations in weather.

The IEC 61730:2023 and IEC 61215 series will soon require compliance with IEC TS 63126 test methods.

The first edition of IEC TS 63126 provided low-resolution world maps of the T_{98} calculated using TMY 3 and for typical PV modules mounted in conventional "rack," "close roof/polymer back" and "insulated back" mounting. But the problem of how to determine T_{98} for modules and systems not conforming to the King model was not addressed.

Here we use data from Fuentes to develop a model and a method for doing a set of measurements on a test PV system where the heat transfer characteristics are summarized into a parameter described as an effective standoff (X_{eff}) between the module frame and the rooftop. This allows for simple maps or look-up tables that were derived for typical PV modules and systems to be used for configurations that do not follow the King model.

Module Standoff vs Temperature



Definition of Model for Temperature

A gap of zero, is represented by an insulated back module. A gap of infinity is an open rack cell temperature. The temperature drops off exponentially with a characteristic distance of 6.1 cm according to:

$$T(X) = T_0 - \Delta T \left(1 - e^{-\frac{X}{X_o}}\right), \text{ Eq. 1} \quad X_{eff} = -X_o \ln \left(1 - \frac{T_0 - T}{\Delta T}\right), \text{ Eq. 2}$$

The standoff distance (X_{eff}) is understood to be an effective distance because factors such as the tiles in Figure 2 or the insulative properties of the roof are not accounted for and affect the temperature. X_{eff} should be thought of as a characteristic heat transfer coefficient that is highly correlated with a physical distance.

Values for X_{eff} can be computed using T_{98} values for the test system and calculated values for a rack mounted and insulated back system from annual data using Equation 2.

Alternatively, X_{eff} can be computed from each meteorological measurement and averaged. However, one should compute the average of the value $(T_0 - T/\Delta T)$ to account for transient behavior and eliminate the need to omit data points that produce irrational numbers.

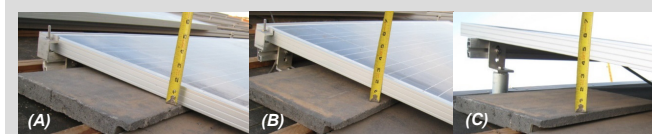
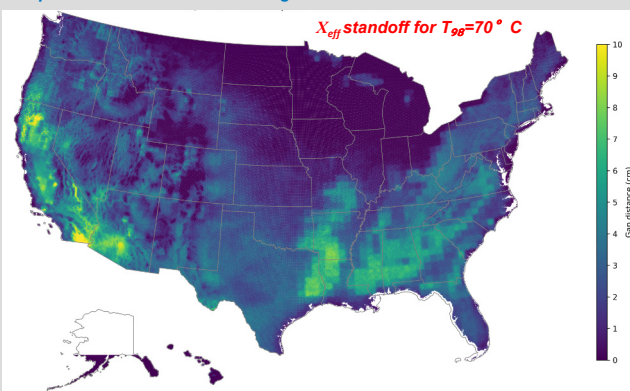


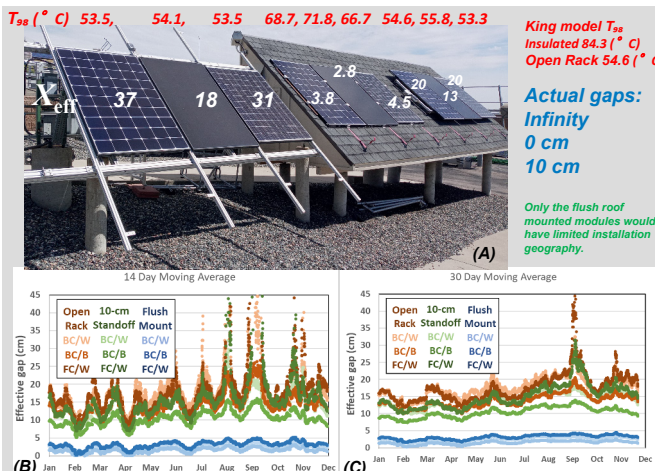
Figure 2 - Images showing a variety of standoff distances of (A) flush mount (B) 2.5 cm (1"), and (C) 10 cm (4").

Maps for X_{eff} Provide Simple Lookup

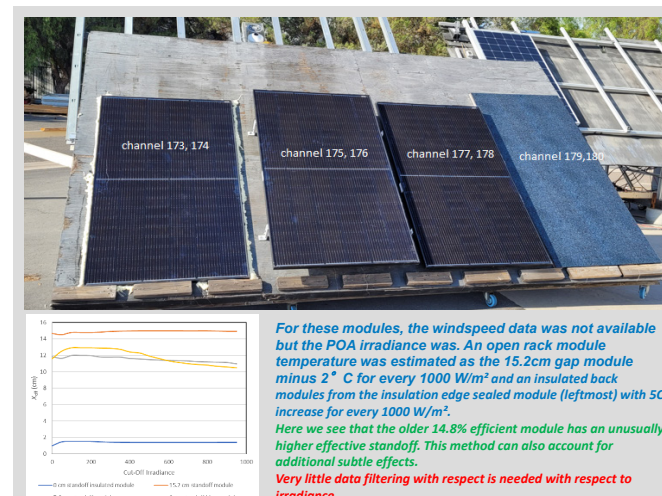
This map, along with one for $T_{98}=80$ °C, allows a system designer to measure X_{eff} for their particular system and determine which regions will require higher levels of temperature certification according to IEC TS 63126.



X_{eff} Determined from System Data

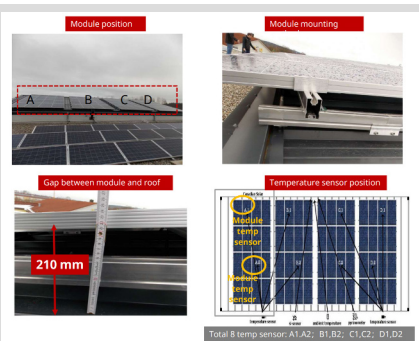


Module Efficiency Affects T_{98}



The Position in the Array Matters

Position in Array	T_{98} (°C)	T_{98} average (°C)
Corner	A1 50.1	-1.5
Side edge	A2 52.7	1.1
Top edge	B1 50.8	-0.8
Center	B2 54.4	2.8
Top edge	C1 50.5	-1.1
Center	C2 53.5	1.9
Corner	D1 50.2	-1.4
Side edge	D2 50.6	-1



- From Corner to center, there is about a 4 °C difference.
- Is this the same for insulated back or Rack mount systems?
- The Fuentes/King model is based on individual modules.
- For real systems, there could be a 4 °C error.

Site Specific Concerns

These high temperatures will be seen in on building integrated systems in warm climates where there are significant restrictions to air flow on the back side of the array. There are many factors that affect the temperature of a roof that may affect the temperature of the modules this includes, but is not limited to:

- Air gap to roof
- Roof and array Size
- Module efficiency
- Roof color and material
- Arrays with some tilt on a rooftop.
- array orientation
- array tilt
- Gaps between modules.
- Roof features and things that affect air flow. (wire trays, pest control, flashing/fire retardant)
- Module level power electronics and how they are attached.
- Mounting structures.
- Building insulative properties (R value).
- Glass vs polymer back
- Module dimensions and composition.
- Thickness of the frame.

An analysis of the array tilt and orientation indicates that a fixed latitude tilt is within about 5 °C of a worst case scenario which is usually oriented at a lower angle and towards the west to be more directly facing the sun during the hottest time of the hottest day of the year.

Summary

We have created a method to produce more intuitive maps and analysis methods to determine when a module must be certified to higher temperature levels under IEC TS 63126. We define an effective standoff, X_{eff} which is a measurement of a system's heat transfer characteristics. This standoff is determined by measuring the temperature of the test mounting system and comparing that to theoretical temperature models for a rack-mounted and an insulated back module and using Eq. (2) to calculate X_{eff} . Then, with the map, or other standardized calculation, both based on the same temperature models, one can simply look up which locations will exceed $T_{98}=70$ °C or 80 °C requiring higher certification levels.

Besides standoff, there are many other factors that this single-module test might not capture. For example, the modules in the center of an array may run much hotter. But with a better understanding of these factors, adjustments can be made to make the determination of T_{98} more repeatable while maintaining much of the simplicity of the interpretation with the method demonstrated here.